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(54) **Apparatus for cutting semiconductor devices**

(57) An apparatus for cutting semiconductor devices comprises cutting blades (132) for cutting a semiconductor device, generally annular rigid spacers, a fluid reservoir (174), an elongated member and an adjustment mechanism. The rigid spacers separate adjacent ones of the cutting blades, the spacers each having an inner surface at its inner radius and an outer surface at its outer radius, and each contacting the adjacent ones of the cutting blades on first and second substantially planar surfaces each extending substantially from the inner surface to the outer surface. The elongated member is in movable proximity to the cutting blades and in fluid communication with the fluid reservoir and has channels configured to at least partially surround the cutting blades so as to simultaneously direct flow of a fluid from the fluid reservoir onto the cutting edges of the cutting blades and onto the sides of the cutting blades. The adjustment mechanism is configured to move the elongated member so as to adjustably align the channels with the cutting blades.

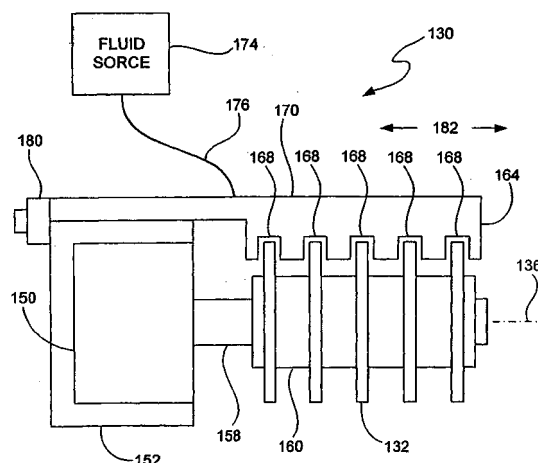


FIG. 5



## EUROPEAN SEARCH REPORT

Application Number  
EP 07 01 4806

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The present search report has been drawn up for all claims			TECHNICAL FIELDS SEARCHED (IPC)
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Place of search		Date of completion of the search	Examiner
Munich		21 May 2010	Frisch, Ulrich
<p>CATEGORY OF CITED DOCUMENTS</p> <p>X : particularly relevant if taken alone Y : particularly relevant if combined with another document of the same category A : technological background O : non-written disclosure P : intermediate document</p> <p>T : theory or principle underlying the invention E : earlier patent document, but published on, or after the filing date D : document cited in the application L : document cited for other reasons ..... &amp; : member of the same patent family, corresponding document</p>			

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**ANNEX TO THE EUROPEAN SEARCH REPORT  
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This annex lists the patent family members relating to the patent documents cited in the above-mentioned European search report.  
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